SWITCHMODE Power Rectifiers

These state-of-the-art devices have the following features:

Features

- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After Board Mounting
- · Guardring for Stress Protection
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- · WF Suffix for Products with Wettable Flanks
- These are Pb-Free and Halide-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

Applications

- Ideally Suited for use as an Output Rectifier in High Frequency (up to 2 MHz) Automotive and Non-Automotive Applications
- Output Rectification in Compact Portable Consumer Applications
- · Freewheeling Diode used with Inductive Loads

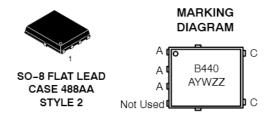


ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 4 AMPERES 40 VOLTS





B440 = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping†	
MBR440MFST1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel	
MBR440MFST3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel	
NRVB440MFST1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel	
NRVB440MFST3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel	
NRVB440MFSWFT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel	
NRVB440MFSWFT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	V _{RRM}		V	
Working Peak Reverse Voltage DC Blocking Voltage	V _{RWM}	40		
DO BIOCKING VOILage	V _R	40		
Average Rectified Forward Current	I _{F(AV)}	4.0	Α	
(Rated V _R , T _C = 165°C)				
Peak Repetitive Forward Current,	I _{FRM}	8.0	А	
(Rated V_R , Square Wave, 20 kHz, $T_C = 165$ °C)				
Non-Repetitive Peak Surge Current	I _{FSM}	40	А	
(Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)				
Storage Temperature Range	T _{stg}	-65 to +175	°C	
Operating Junction Temperature	TJ	-55 to +175	°C	
Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive)	E _{AS}	10	mJ	
ESD Rating (Human Body Model)		3B		
ESD Rating (Machine Model)		M4		

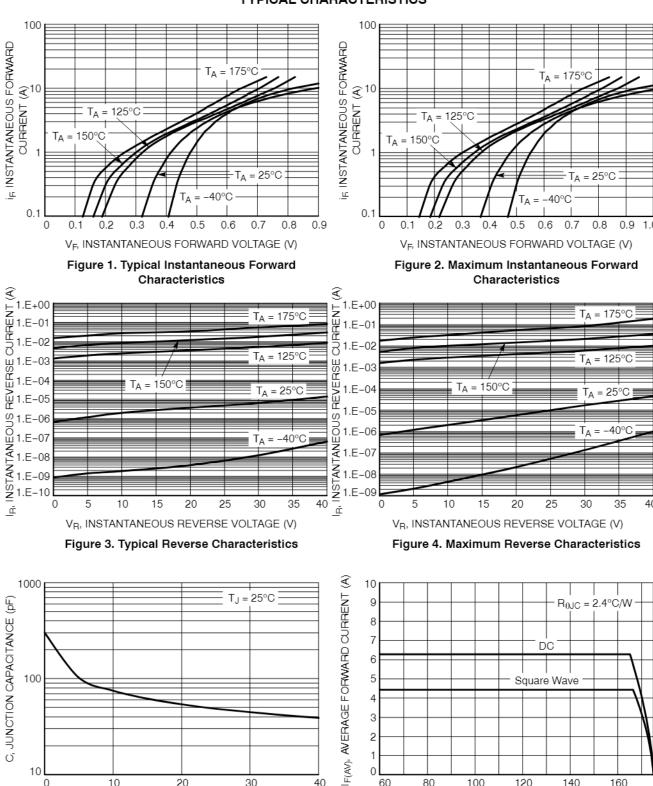
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board)	R _{eJC}	-	2.4	°C/W
ELECTRICAL CHARACTERISTICS	•			
Instantaneous Forward Voltage (Note 1) ($i_F = 4 \text{ Amps}, T_J = 125^{\circ}\text{C}$) ($i_F = 4 \text{ Amps}, T_J = 25^{\circ}\text{C}$)	VF	0.58 0.59	0.63 0.65	V
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T _J = 125°C) (Rated dc Voltage, T _J = 25°C)	i _R	10 0.070	15 0.8	mA

^{1.} Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

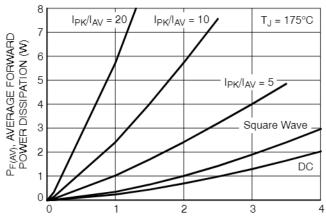
TYPICAL CHARACTERISTICS



V_R, REVERSE VOLTAGE (V) Figure 5. Typical Junction Capacitance

T_C, CASE TEMPERATURE (°C) Figure 6. Current Derating TO-220AB

TYPICAL CHARACTERISTICS



I_{F(AV)}, AVERAGE FORWARD CURRENT (A)

Figure 7. Forward Power Dissipation

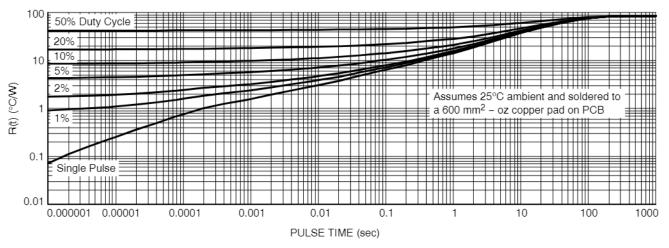
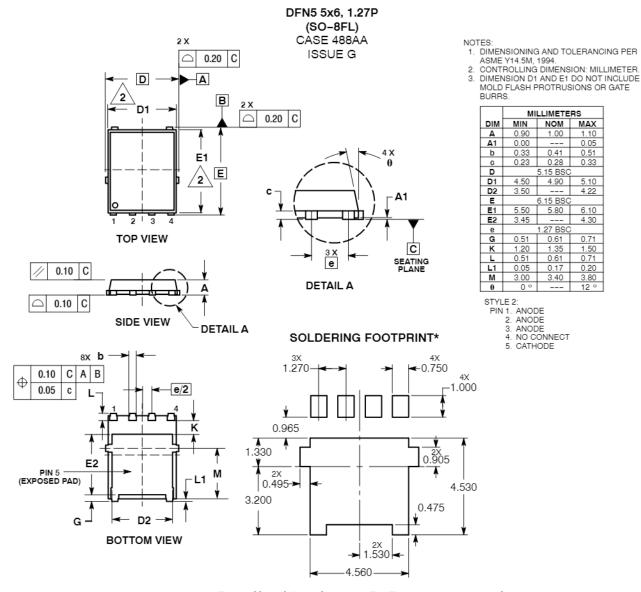


Figure 8. Thermal Characteristics

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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